

XBT-3535-UV-Mini

Surface Mount UVC LED



Features

- UV LED with peak wavelength 275 nm
- 30 mW power output at max rated current
- Compact form factor: 3.5 mm x 3.5 mm package with optically transparent window
- Viewing angle of 130 degrees
- Standard SMT process



Applications

- Water/ Air/ Surface Disinfection
- Healthcare
- Food & Pharmaceutical Processing
- Analytical Instruments
- Horticulture

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Ordering Information

Ordering Part Numbers¹

Wavelength Range (nm)	Wavelength Bins	Radiometric Flux		Ordering Part Number
		Bin Kit Flux Code	Min. Flux (mW)	
270 - 280	270, 275	BC	14	XBT-3535-UV-A130H-M-BC270-00

Part Number Nomenclature

XBT 3535 UV A130H-M <FFWWWW-#>

Product Family	Package Size	Color	Package Configuration	Bin Kit
XBT: UVC Surface Mount Package	3535: 3.5 mm ²	UV: Ultraviolet	A130H-M: 130 degree viewing angle, Mini	Flux and Wavelength bin kit code - See ordering information

Note:

1. Flux Bin listed is minimum bin shipped, higher bins may be included at Luminus' discretion.



Binning Structure

XBT-3535-UV-Mini LEDs are tested at a drive current of 150 mA, 20 ms single pulse at 25°C and placed into one of the following radiometric flux and wavelength bins. The LEDs can also be driven at different drive currents to achieve the correlated flux values listed in the table.

Radiometric Flux Bins^{1,2}

Color	Flux Bin ³	Binning @ 150 mA, T _c = 25°C ^{4,5}		Correlated Minimum Flux (mW) @ T _c = 25°C		
		Minimum Flux (mW)	Maximum Flux (mW)	50 mA	100 mA	225 mA
UV	BC	14	16	4.7	9.3	21.0
	BD	16	18	5.3	10.7	24.0
	BE	18	20	6.0	12.0	27.0
	BF	20	22	6.7	13.3	30.0
	CA	22	25	7.3	14.7	33.0
	CB	25	30	8.3	16.7	37.5
	CC	30	35	10.0	20.0	45.0
	CD	35	40	11.7	23.3	52.5

Wavelength Bins²

Color	Wavelength Bin ^{3,6}	Binning @ 150 mA, T _c = 25°C ^{4,5}	
		Minimum Wavelength (nm)	Maximum Wavelength (nm)
UV	270	270	275
	275	275	280

Forward Voltage Bins

Color	Voltage Bin	Binning @ 150 mA, T _c = 25°C	
		Minimum Voltage (V)	Maximum Voltage (V)
UV	V3	5.0	5.5
	V4	5.5	6.0
	V5	6.0	6.5
	V6	6.5	7.0
	V7	7.0	7.5

Note:

1. Luminus maintains a +/- 6% tolerance on flux measurements.
2. Products are production tested then sorted and packed by bin.
3. Individual bins are not orderable. Please refer to the Product Ordering information page for a list of orderable bin kits.
4. Product test condition: 150 mA, 20 ms pulse at 25 °C.
5. T_c = Case temperature.
6. The wavelength bin as marked on the product label may be followed by a letter which is for internal use only.



Absolute Maximum Ratings¹

Parameter	Symbol	Value	Unit
Forward Current	$I_{f\max}$	225	mA
Storage Temperature	$T_{s\min}$	-40	°C
	$T_{s\max}$	100	
Junction Temperature	$T_{j\max}$	100	°C
ESD sensitivity ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)	V_{ESD}	8000	V

Note:

1. XBT-3535-UV-Mini LEDs are designed for operation up to an absolute maximum forward drive current as specified above. Product lifetime data is specified at typical forward drive currents. Sustained operation at absolute maximum currents will result in a reduction of device lifetime compared to typical forward drive currents. Actual device lifetimes will also depend on junction temperature.



Characteristics^{1,2}

Optical and Electrical Characteristics	Symbol	Value	Unit
Test Current	I_f	150	mA
Forward Voltage	$V_{f_{\min}}$	5.0	V
	$V_{f_{\text{typ}}}$	5.9	
	$V_{f_{\max}}$	7.5	
FWHM	$\Delta\lambda$	13	nm
Viewing Angle	$2\theta_{1/2}$	130	°
Thermal Characteristics			
Thermal Resistance (junction to case) ³	$R_{\theta_{j-c}}$	12.7	°C/W

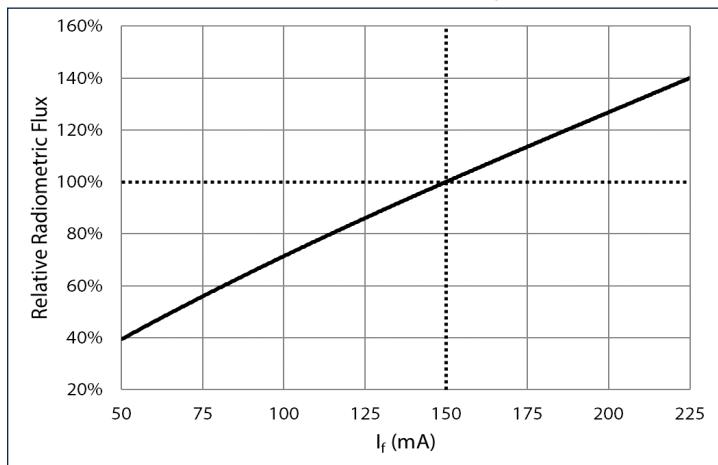
Note:

1. Ratings are based on operation at a constant temperature of $T_c = 25^\circ\text{C}$. Test conditions: 150 mA, 20 ms pulse at 25°C .
2. XBT-3535-UV-Mini LEDs are short wavelength, deep UV LEDs. During operation, the LED emits high intensity UVC radiation, which is harmful to skin and eyes. UV light is also hazardous to skin and may cause cancer. Avoid exposure to deep UV light when LED is operational.
3. Measurements are in accordance with JEDEC 51-14.

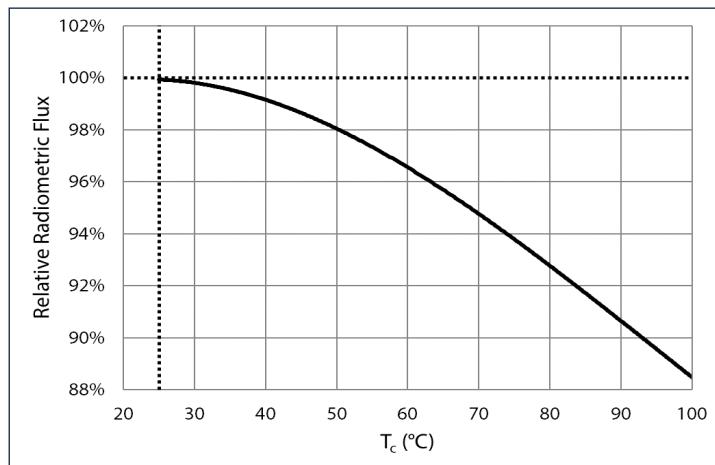


Relative Radiometric Flux

Forward current: $\phi_v/\phi_v(150 \text{ mA})$, 20 ms pulse, $T_c = 25^\circ\text{C}$

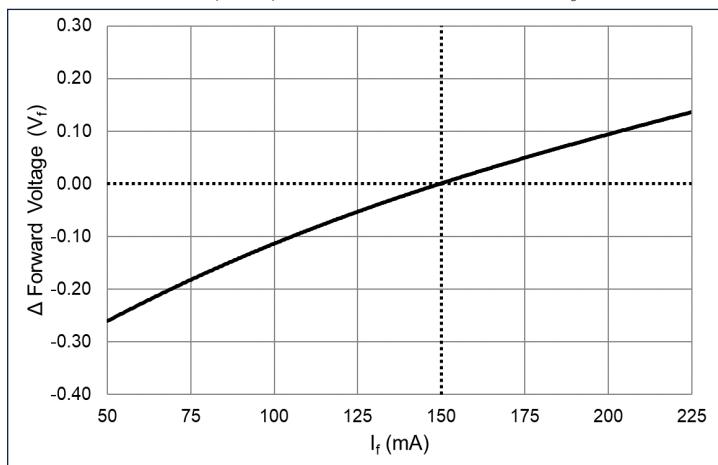


Temperature: $\phi_v/\phi_v(25^\circ\text{C})$, 20 ms pulse, $I_f = 150 \text{ mA}$

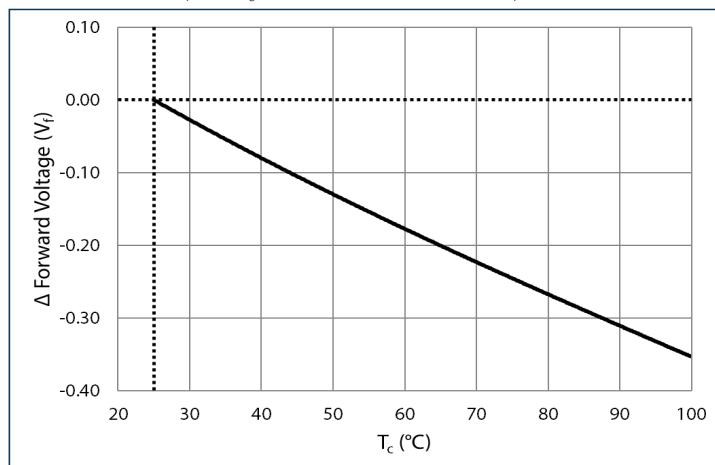


Forward Voltage Shift

Forward current: $\Delta V_f = V(I_f) - V(150 \text{ mA})$, 20 ms pulse, $T_c = 25^\circ\text{C}$

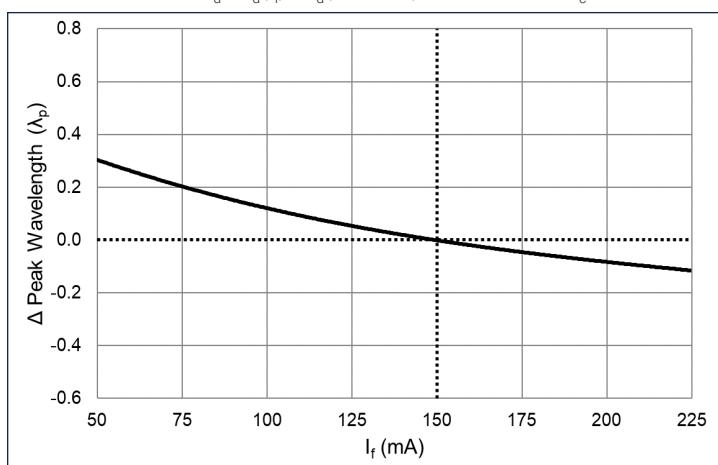


Temperature: $\Delta V_f = V(T_c) - V(25^\circ\text{C})$, 20 ms pulse, $I_f = 150 \text{ mA}$

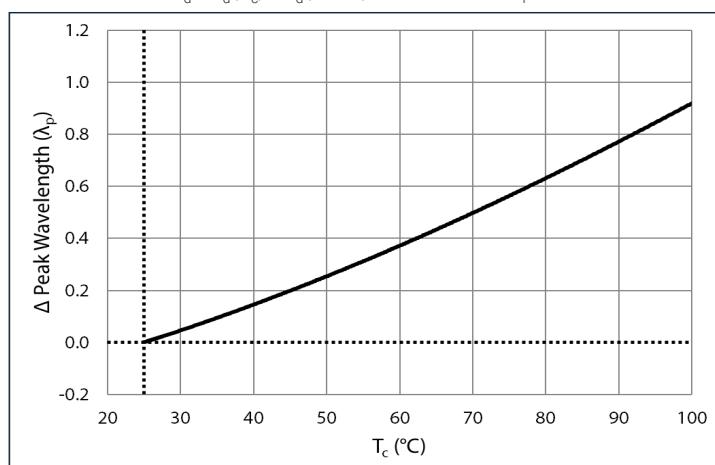


Peak Wavelength Shift

Forward current: $\Delta \lambda_d = \lambda_d(I_f) - \lambda_d(150 \text{ mA})$, 20 ms pulse, $T_c = 25^\circ\text{C}$



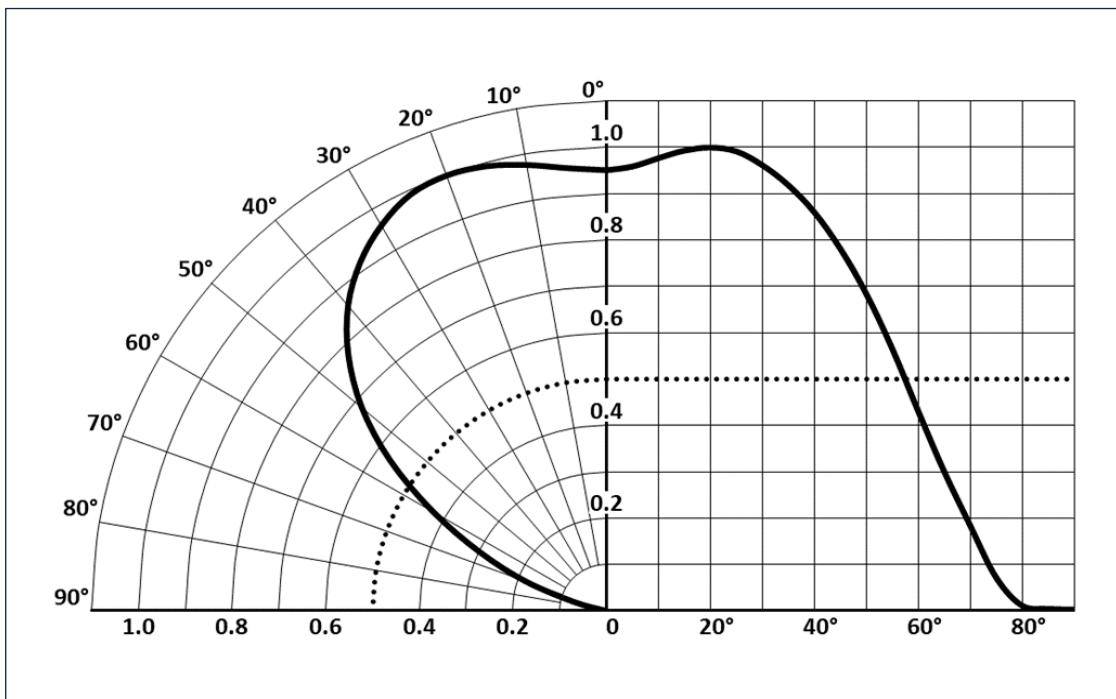
Temperature: $\Delta \lambda_d = \lambda_d(T_c) - \lambda_d(25^\circ\text{C})$, 20 ms pulse, $I_f = 150 \text{ mA}$



Angular distribution and Typical Spectrum

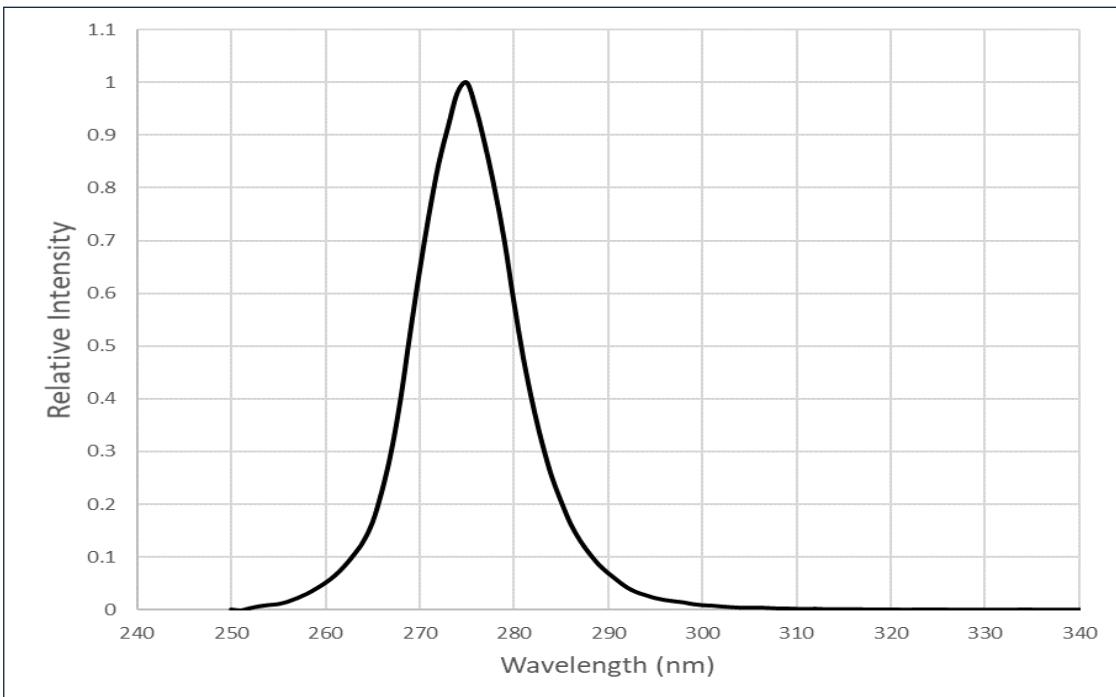
Angular distribution

$I_{ref} = f(\Phi)$; $T_c = 25^\circ\text{C}$



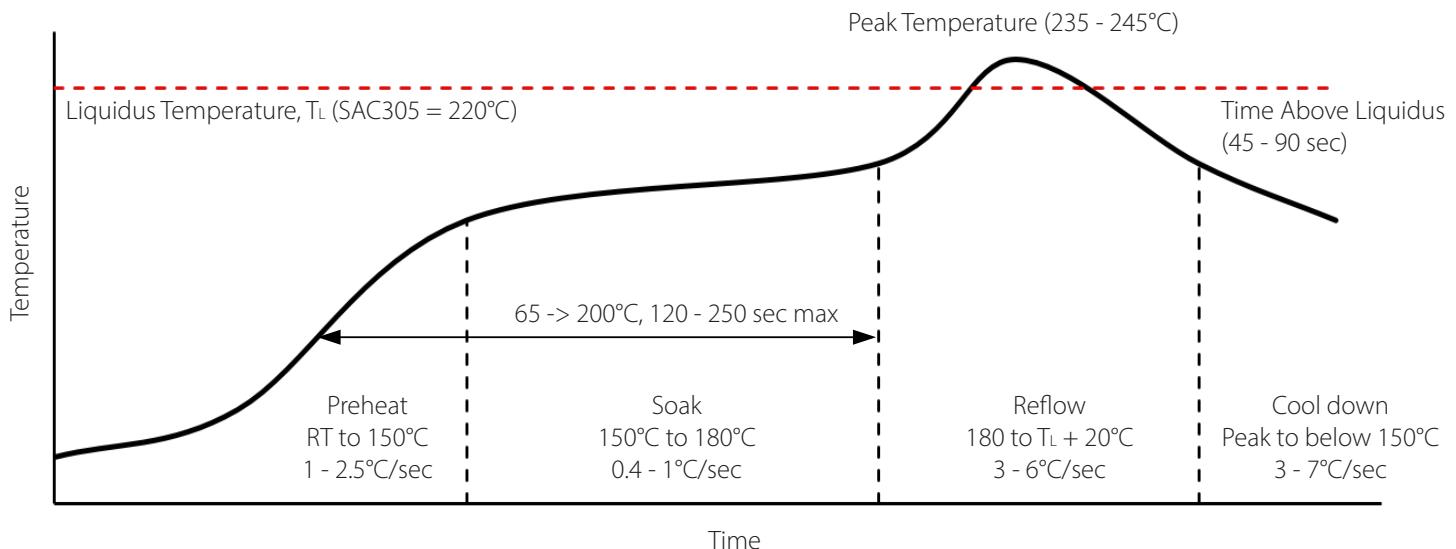
Typical Spectrum

$\Phi_{ref} = f(\lambda)$; $I_f = 150 \text{ mA}$; $T_c = 25^\circ\text{C}$





Soldering Profile



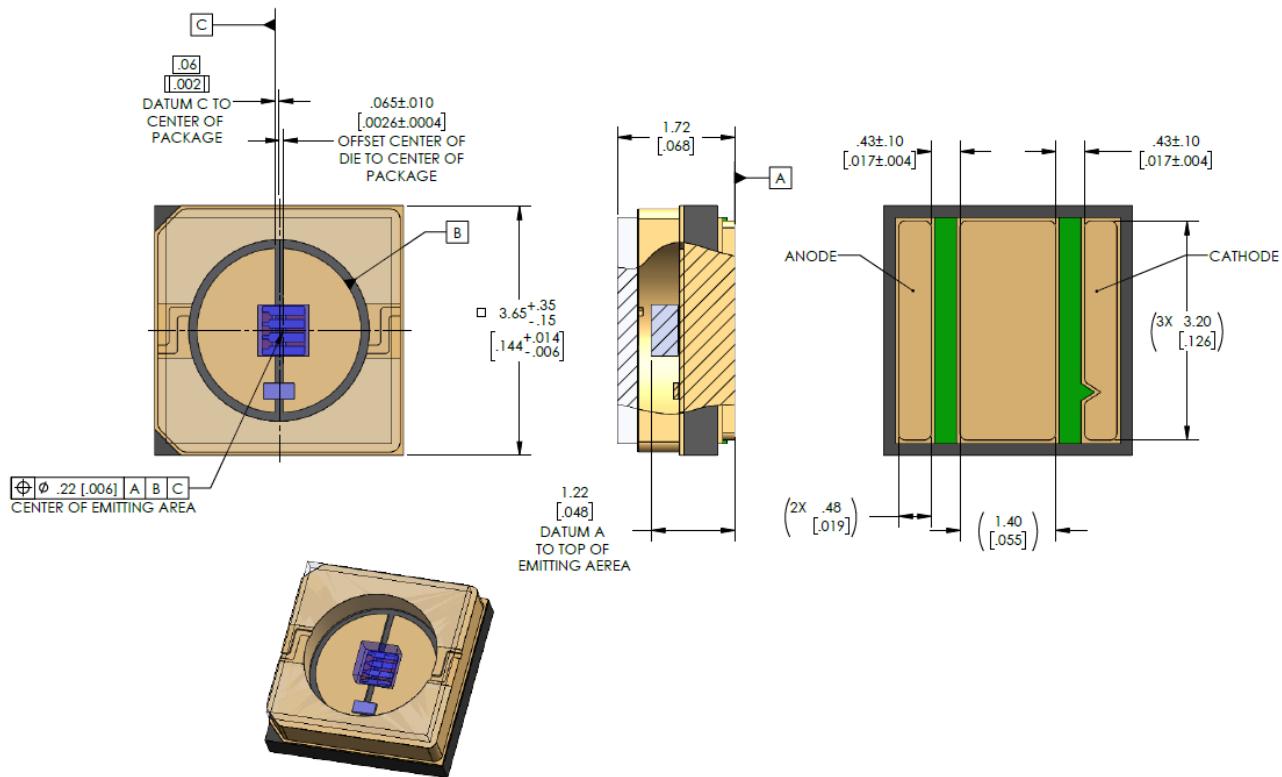
SMT Rework Guideline	Manual Hotplate Reflow	Hot Air Gun Reflow
Heating Time	< 60 sec	
Hotplate Temperature	< 245°C	< 150°C

Note:

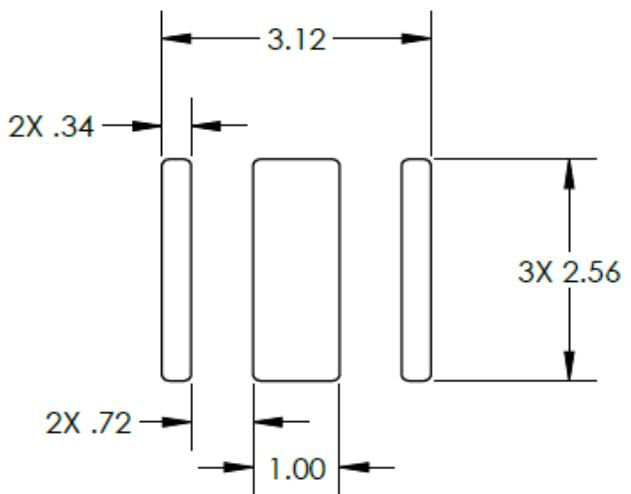
1. Product complies to Moisture Sensitivity Level 1 (MSL 1).
2. The numbers in the table are specific to SAC305. Luminus recommends using an SAC305 solder paste with a no-clean flux for RoHS compliant products.
3. During the pick and place process, axial forces on the dome (or window) should not exceed 0.5 Newtons (N).
4. Use of a multi-zone IR reflow oven with a nitrogen blanket is recommended.
5. Time-temperature profile of the reflow process showing the four functional profile zones are defined in IPC-7801. Temperature is referenced to the center of the PCB.
6. Luminus recommends to use the solder paste data sheet information as a starting point in time-temperature process development.
7. These are general guidelines. Consult the solder paste manufacturer's datasheet for guidelines specific to the alloy and flux combination used in your application.
For more information, please refer to:
<https://luminusdevices.zendesk.com/hc/en-us/articles/360060306692-How-do-I-Reflow-Solder-Luminus-SMD-Components->
8. For any technical questions about soldering process, please contact Luminus at techsupport@luminus.com.



Mechanical Dimensions



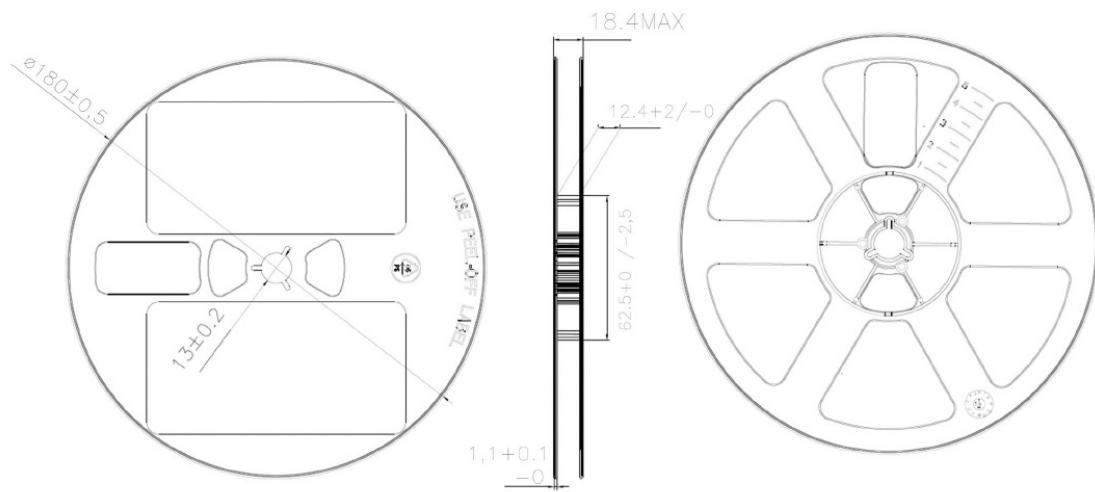
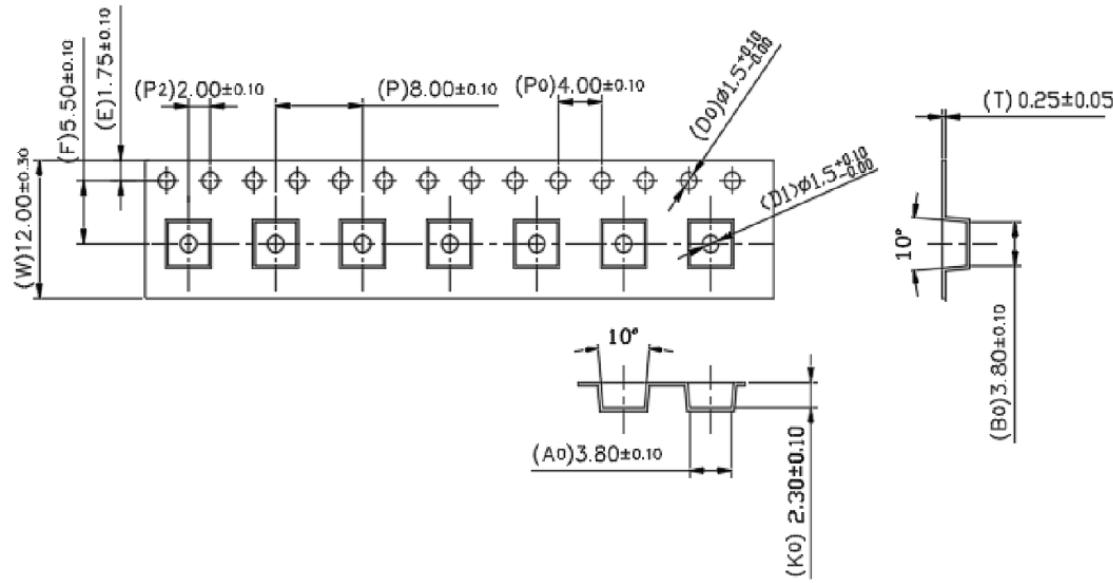
Recommended Solder Pad



Shipping Reel Outline

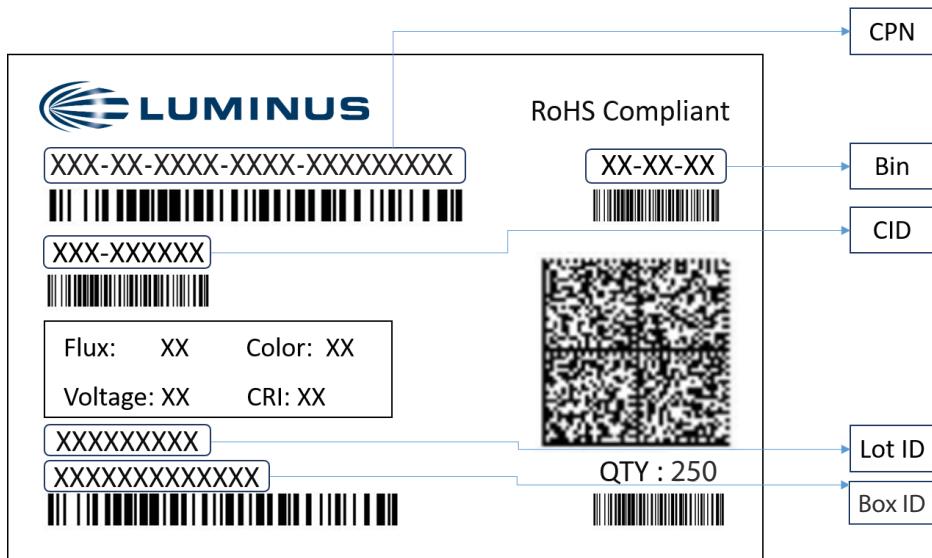
All XBT-3535 products are packaged and labeled with their respective bin as outlined in the tables on page 3.

Each reel will only contain one flux and one wavelength bin.





Shipping Label



Label Fields:

- CPN: Luminus ordering part number
- CID: Customer's part number
- QTY: Quantity of devices in pack
- Flux: Bin as defined on page 3
- Wavelength: Bin as defined in page 3
- Voltage: Bin as defined on page 3
- Color: Bin as defined on page 3
- CRI: NA

Packing Configuration:

- Maximum of 250 devices per reel, minimum of 50 devices per reel
- Partial reels may be shipped
- Each reel is enclosed in anti-static bag
- Shipping label is placed on top of each pack



Notes

Static Electricity

This product is sensitive to static electricity, and care should be taken when handling them. Static electricity or surge voltage will damage the LEDs. It is recommended to wear an anti-electrostatic wristband or anti-electrostatic gloves when handling the LEDs. All devices, equipment and machinery must be properly grounded. It is recommended that measures be taken to isolate LED processing equipment from potential sources of voltage surges.

Reference: APN-002815 Electrical Stress Damage to LEDs and How to Prevent It

Eye Safety

According to the test specification risk group IEC 62471: 2008-Non-GLS under 150 mA, this product complies to Risk group 3 (RG3) High risk, exceed the limits for Risk Group 2.

Warning: This product emits invisible light - there is no aversion response.

Avoid eye and skin exposure to un-shielded product.

For more information, please refer to: <https://luminusdevices.zendesk.com/hc/en-us/articles/10532958752397>



Revision History

Rev	Date	Description of Change
01	11/17/2023	Initial release.
02	04/11/2024	Added the maximum flux bins.
03	08/06/2024	Editorial change - flux bin table.

Mouser Electronics

Authorized Distributor

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